

# **APT1608YC**

1.6 x 0.8 mm SMD Chip LED Lamp



# DESCRIPTION

• The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode

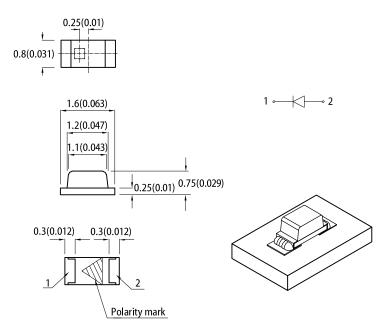
# **FEATURES**

- 1.6 mm x 0.8 mm SMD LED, 0.75 mm thickness
- Low power consumption
- Wide viewing angle
- · Ideal for backlight and indicator
- Package: 2000 pcs / reel
- · Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

# **APPLICATIONS**

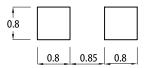
- Backlight
- Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- Healthcare applications

# **PACKAGE DIMENSIONS**



#### **RECOMMENDED SOLDERING PATTERN**

(units : mm; tolerance : ± 0.1)



Notes

1. All dimensions are in millimeters (inches).

- Tolerance is ±0.1(0.004") unless otherwise noted.
   The specifications, characteristics and technical data described in the datasheet are subject to
- change without prior notice. 4. The device has a single mounting surface. The device must be mounted according to the specifications

## **SELECTION GUIDE**

Part Number	Emitting Color	Lens Type	lv (mcd) @ 20mA <sup>[2]</sup>		Viewing Angle <sup>[1]</sup>	
Fait Number	(Material)	Lens Type	Min.	Тур.	201/2	
APT1608YC	Yellow (GaAsP/GaP)	Water Clear	3	8	150°	

Notes

- 41/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
   2. Luminous intensity / luminous flux: +/-15%.
   3. Luminous intensity value is traceable to CIE127-2007 standards.

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## ELECTRICAL / OPTICAL CHARACTERISTICS at T<sub>A</sub>=25°C

Parameter	Querra ha al	Enclution Onlyn	Value		Unit
Parameter	Symbol	Emitting Color	Typ. Max.		
Wavelength at Peak Emission $I_F$ = 20mA	$\lambda_{peak}$	Yellow	590	-	nm
Dominant Wavelength $I_F$ = 20mA	$\lambda_{dom}$ <sup>[1]</sup>	Yellow	588	-	nm
Spectral Bandwidth at 50% $\Phi$ REL MAX I <sub>F</sub> = 20mA	Δλ	Yellow	35	-	nm
Capacitance	С	Yellow	20	-	pF
Forward Voltage I <sub>F</sub> = 20mA	V <sub>F</sub> <sup>[2]</sup>	Yellow	2.1	2.5	V
Reverse Current (V <sub>R</sub> = 5V)	I <sub>R</sub>	Yellow	-	10	μA
Temperature Coefficient of $\lambda_{\text{peak}}$ $I_F$ = 20mA, -10°C $\leq T \leq 85^\circ C$	TC <sub>λpeak</sub>	Yellow	0.12	-	nm/°C
Temperature Coefficient of $\lambda_{dom}$ $I_F$ = 20mA, -10°C $\leq T \leq 85^\circ C$	TC <sub>λdom</sub>	Yellow	0.07	-	nm/°C
Temperature Coefficient of $~V_F$ $I_F$ = 20mA, -10°C $\leq$ T $\leq$ 85°C	TCv	Yellow	-2	-	mV/°C

Notes: 1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.) 2. Forward voltage: ±0.1V. 3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

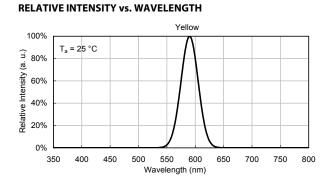
# ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	P <sub>D</sub>	75	mW
Reverse Voltage	V <sub>R</sub>	5	V
Junction Temperature	Tj	110	°C
Operating Temperature	T <sub>op</sub>	-40 to +85	°C
Storage Temperature	T <sub>stg</sub>	-40 to +85	°C
DC Forward Current	I <sub>F</sub>	30	mA
Peak Forward Current	I <sub>FM</sub> <sup>[1]</sup>	140	mA
Electrostatic Discharge Threshold (HBM)	-	8000	V
Thermal Resistance (Junction / Ambient)	R <sub>th JA</sub> <sup>[2]</sup>	560	°C/W
Thermal Resistance (Junction / Solder point)	R <sub>th JS</sub> <sup>[2]</sup>	380	°C/W

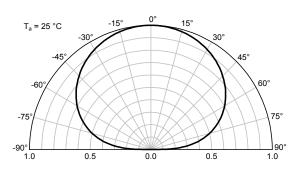
Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. R<sub>In. J.A</sub> , R<sub>In. J.S</sub> Results from mounting on PC board FR4 (pad size ≥ 16 mm<sup>2</sup> per pad). 3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

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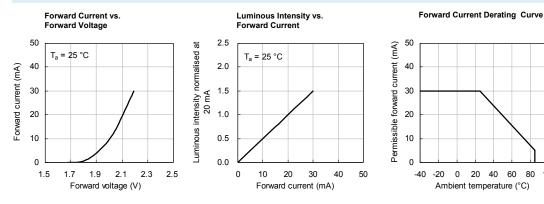
# **TECHNICAL DATA**

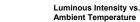


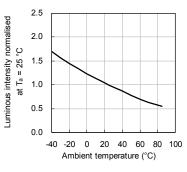
#### SPATIAL DISTRIBUTION



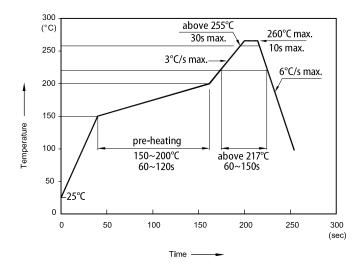
#### YELLOW







#### **REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS**



#### Notes

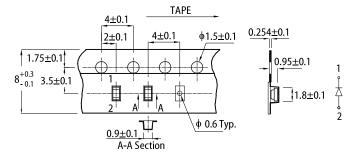
1. Don't cause stress to the LEDs while it is exposed to high temperature.

- The maximum number of reflow soldering passes is 2 times.
   Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

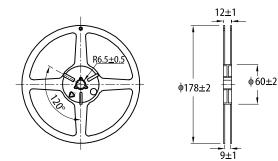
#### TAPE SPECIFICATIONS (units : mm)

-20 0 20 40 60 80 100

Ambient temperature (°C)



#### **REEL DIMENSION** (units : mm)



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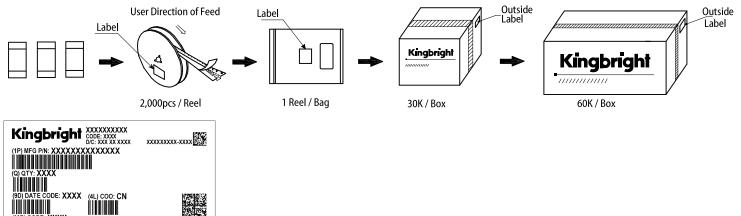
(SP)XXXXXXXXXXX

XXX

# **APT1608YC**

### **PACKING & LABEL SPECIFICATIONS**

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- PRECAUTIONARY NOTES
  The information included in this document reflects representative usage scenarios and is intended for technical reference only.
  The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to
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